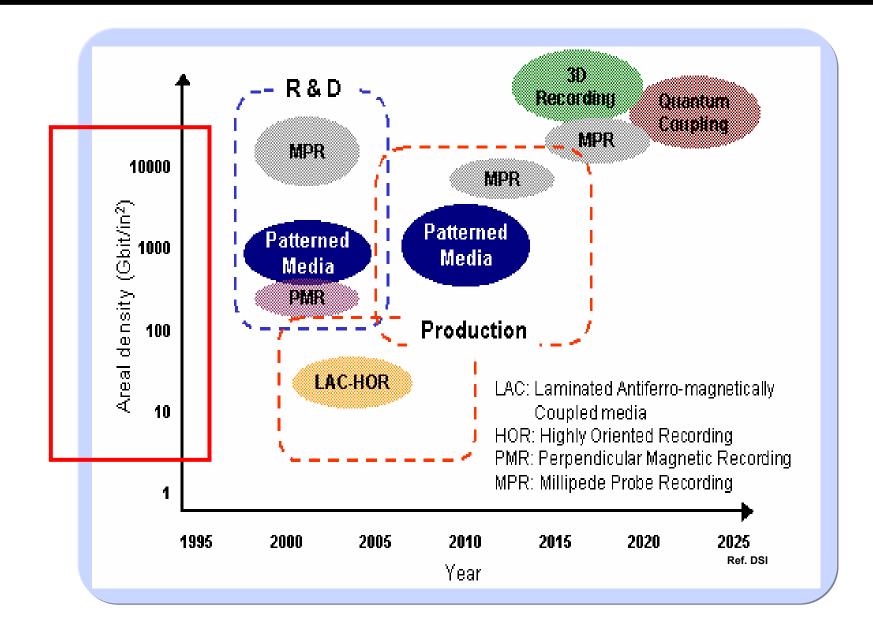
Nano-Injection Molding Technology for Ultra-High-Density Patterned Magnetic Media

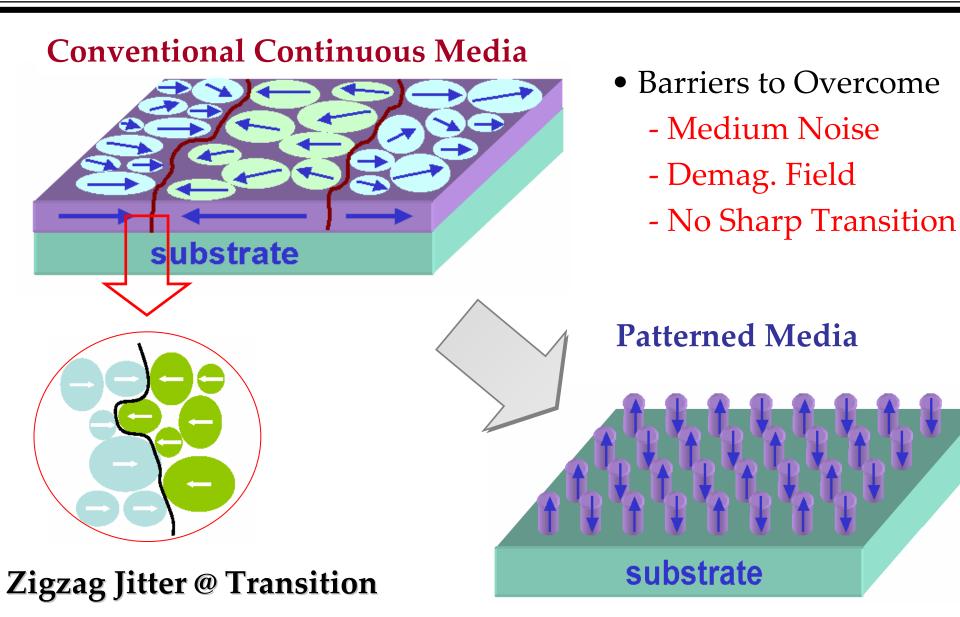
N. Lee<sup>1</sup>, J. Shim<sup>2</sup>, J. Hong<sup>2</sup> and S. Kang<sup>1</sup>

<sup>1</sup>Mechanical Engineering <sup>2</sup>Advanced Materials Engineering Yonsei University, Seoul, Korea

### Demand for Ultra-High-Density Magnetic Media



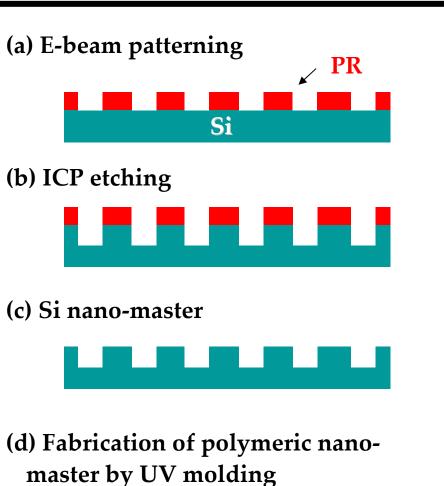
## **Motivation for Patterned Media**

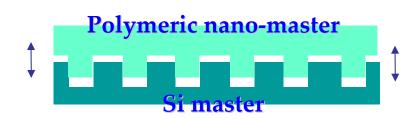


## Various Technologies for Patterned Media

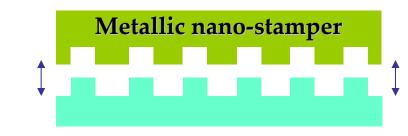
resist **Direct Patterning** magnetic layer A. E-beam Lithography Si **B.** Defining Magnetic Islands by **1. Focused Ion Beam (FIB)** 2. Reactive Ion Etching (RIE) 3. Ion-Beam Milling Nano-Imprinting Technology magnetic layer Si Those technologies are fine BUT Not appropriate for mass-production due to low throughput, low yield and high cost!

# **Processes for Nano-Injection Molding Technology**





(e) Fabrication of metallic nano-stamper by electroforming



(f) Nano-injection molding



(g) Polymeric pillar patterns

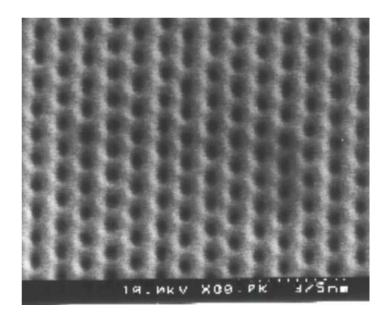
Polymeric patterns

(h) Deposition of magnetic materials

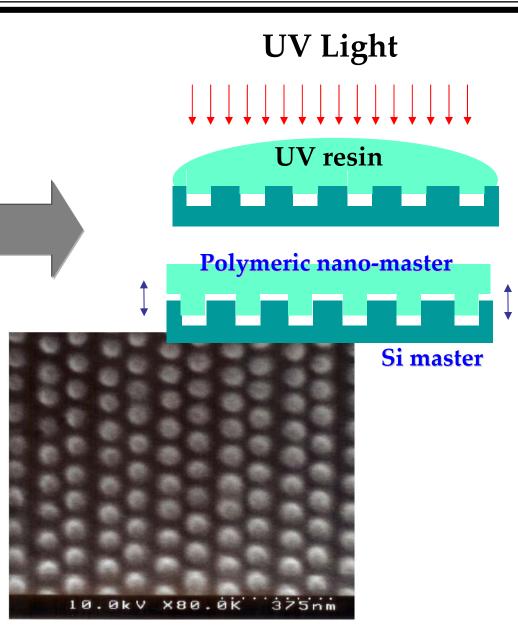
### Fabrication of Polymeric Nano-Master

#### Si Master

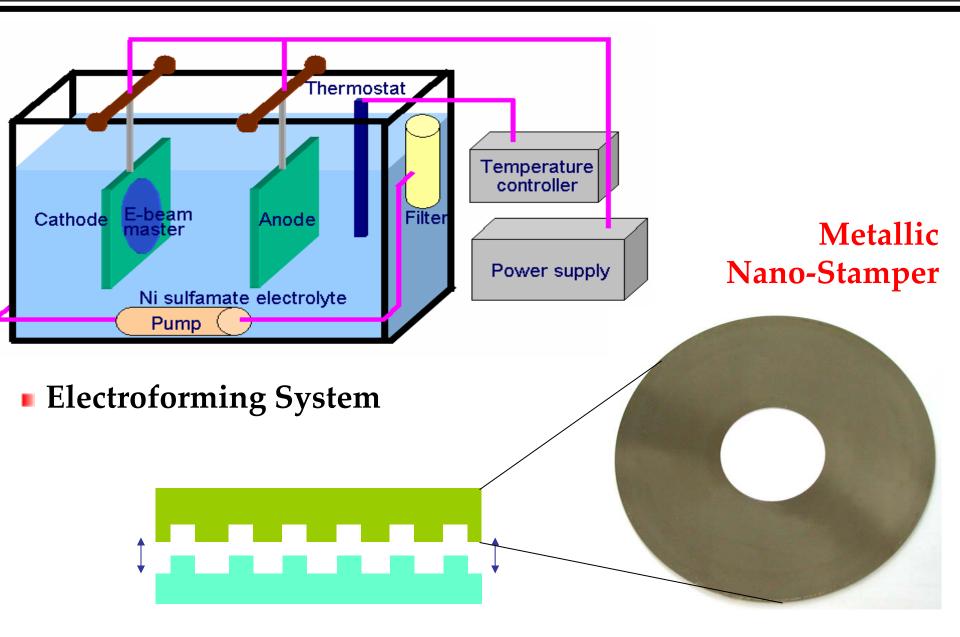
#### (CD: 40nm, pitch: 80 nm)



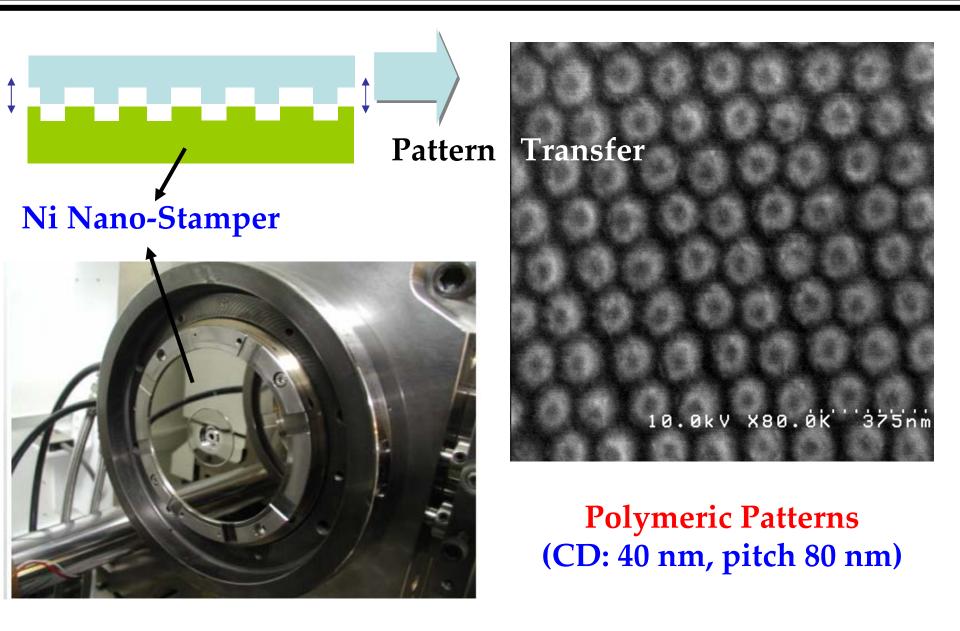
Polymeric Nano-Master by UV Molding



### Fabrication of Metallic Nano-Stamper



## Nano-Injection Molding Technology

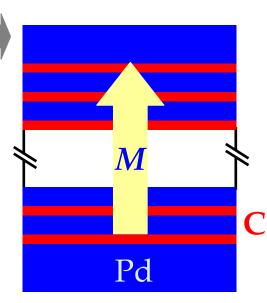


### **Deposition of Magnetic Materials**

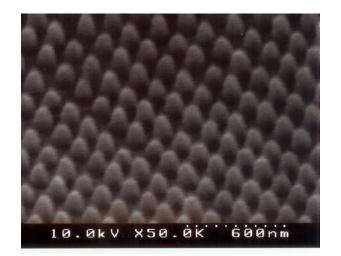


Polymeric Patterns

Magnetic Islands on 3.5 inch Media (CD: 40 nm, pitch 80 nm)



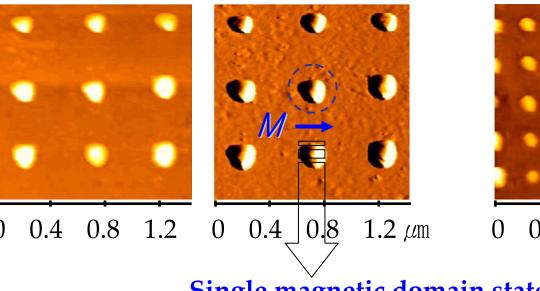
10.0kV X50.0k 600mm



[Pd/Co]<sub>10</sub>

Perpendicular Magnetic Media

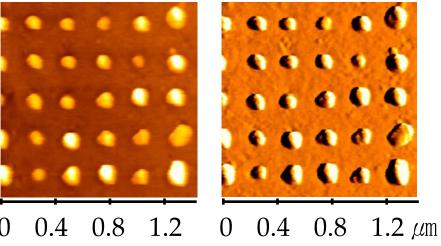
### **Previous Studies and Acknowledgment**



(1) CD: 200 nm, pitch 500 nm

### Nanotechnology, 15 (8), 901-906, 2004

(2) CD: 100 nm, pitch 250 nm



Single magnetic domain state

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